

Data sheet acquired from Harris Semiconductor SCHS040D – Revised October 2003

### **CMOS**

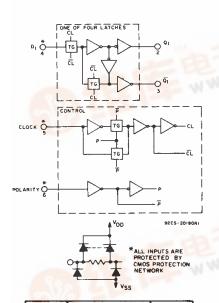
## Quad Clocked "D" Latch

High-Voltage Types (20-Volt Rating)

circuits, each strobed by a common clock. Complementary buffered outputs are available from each circuit. The impedance of the n- and p-channel output devices is balanced and all outputs are electrically identical. Information present at the data input is

Information present at the data input is transferred to outputs Q and Q during the CLOCK level which is programmed by the POLARITY input. For POLARITY = 0 the transfer occurs during the 0 CLOCK level and for POLARITY = 1 the transfer occurs during the 1 CLOCK level. The outputs follow the data input providing the CLOCK and POLARITY levels defined above are present. When a CLOCK transition occurs (positive for POLARITY = 0 and negative for POLARITY = 1) the information present at the input during the CLOCK transition is retained at the outputs until an opposite CLOCK transition occurs.

The CD4042B types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffixes), 16-lead dual-in-line plastic package (E suffix), 16-lead small-outline packages (D, DR, DT, DW, DWR, and NSR suffixes), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).



CLOCK	POLARITY	Q
0	0	D
	0	LATCH
1	1	D
PL	)F1	LATCH
A =	The sale between the street	

Fig. 1 - Logic block diagram and truth table.

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# CD4042B Types

#### Features:

- Clock polarity control
- Q and Q outputs
- **Common clock**
- Low power TTL compatible
- Standardized symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- Maximum input current of 1 μA at 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- 5-V, 10-V, and 15-V parametric ratings
- Noise margin (over full package temperature range):

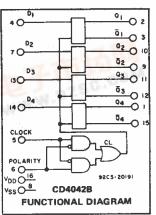
1 V at V<sub>DD</sub> = 5 V 2 V at V<sub>DD</sub> = 10 V

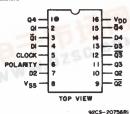
2.5 V at V<sub>DD</sub> = 15 V

Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

#### Applications:

- **■** Buffer storage
- Holding register
- General digital logic





TERMINAL ASSIGNMENT

#### STATIC ELECTRICAL CHARACTERISTICS

CHARAC- TERISTIC	CONE	VIN		LIMITS AT INDICATE			TED TE	TEMPERATURES (°C)			UNITS		
	(V)	(V)	V <sub>DD</sub>	-55	-40	+85	+125	Min.	Тур.	Max.			
Quiescent	_	0,5	5	1	1	30	30	m	0.02	1			
Device		0,10	10	2	2	60	60		0.02	2			
Current		0,15	15	4	4	120	120	_	0.02	4	μΑ		
IDD Max.		0,20	20	20	20	600	600	_	0.04	20			
Output Low													
(Sink)	0.4	0,5	5	0.64	0.61	0.42	0.36	0.51	1	_			
Current,	0.5	0,10	10	1.6	1.5	1.1	0.9	1.3	2.6	1-			
IOL Min.	1.5	0,15	15	4.2	4	2.8	2.4	3.4	6.8	-	^		
Output High	4.6	0,5	5	-0.64	-0.61	-0.42	-0.36	-0.51	-1	_	mA		
(Source)	2.5	0,5	5	-2	-1.8	-1.3	-1.15	-1.6	-3.2	_	]		
Current,	9.5	0,10	10	-1.6	-1.5	_1.1	0.9	-1.3	-2.6	-			
I <sub>OH</sub> Min.	13.5	0,15	15	-4.2	-4	-2.8	-2.4	-3.4	-6.8	-			
Output Volt-						-	-1-1		a C.	10.0			
age:	_	0,5	5	_	0.0	)5		u TO	. 0	0.05			
Low-Level,	-	0,10	10		0.0	)5	41.4	_	0	0.05			
VOL Max.	_	0,15	15		0.0	)5		_	0	0.05	v		
Output Volt-							· · · · · · · · · · · · · · · · · · ·				ľ		
age:	_	0,5	5		4.9	95		4.95	5	_			
High-Level,	DE.	0,10	10	75.1	9.9	95		9.95	10	_	1		
VOH Min.	_	0,15	15		14.	95		14.95	15	1 - 1	1		
Input Low	0.5,4.5		5	<del></del>	1.5				_	1.5			
Voltage,	1,9	_	10		3			<u> </u>	_	3			
VIL Max.	1.5,13.5	_	15	4			-	-	4	١.,			
Input High	0.5,4.5	_	5	3.5			3.5	-	_	\ \			
Voltage,	1,9	_	10					7	_	_			
VIH Min.	1.5,13.5	_	15		1	1		11	-	-			
Input Current, I <sub>IN</sub> Max.	_	0,18	18	±0.1	±0.1	±1	±1	_	±10-5	±0.1	μΑ		

### CD4042B Types

MAXIMUM RATINGS, Absolute-Maximum Values:
DC SUPPLY-VOLTAGE RANGE, (VDD)
Voltages referenced to VSS Terminal)0.5V to +20V
INPUT VOLTAGE RANGE, ALL INPUTS0.5V to V <sub>DD</sub> +0.5V
DC INPUT CURRENT, ANY ONE INPUT ±10mA
POWER DISSIPATION PER PACKAGE (PD):
For T <sub>A</sub> = -55°C to +100°C
For T <sub>A</sub> = +100°C to +125°C
DEVICE DISSIPATION PER OUTPUT TRANSISTOR
FOR TA = FULL PACKAGE-TEMPERATURE RANGE (All Package Types)
OPERATING-TEMPERATURE RANGE (T <sub>A</sub> )55°C to +125°C
STORAGE TEMPERATURE RANGE (T <sub>stg</sub> )65°C to +150°C
LEAD TEMPERATURE (DURING SOLDERING):
At distance 1/16 $\pm$ 1/32 inch (1.59 $\pm$ 0.79mm) from case for 10s max +265°C

RECOMMENDED OPERATING CONDITIONS at  $T_A = 25^{\circ}C$ , Except as Noted. For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTIC	V <sub>DD</sub>	LIM	UNITS		
	(V)	Min.	Max.	1	
Supply-Voltage Range (For TA=Full Package Temperature Range)	_	3	18	v	
	5	200	_		
Clock Pulse Width, tw	10	100	-	ns	
	15	60	-	Į.	
*****	5	50			
Setup Time, tS	10	30	-	ns	
	15	25	L		
	5	120	_		
Hold Time, tH	10	60	-	ns	
	15	50	_		
Clock Rise or Fall Time: t <sub>r</sub> , t <sub>f</sub>	5,10 15		e or fall ensitive.	μS	

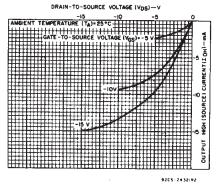


Fig. 5 — Minimum output high (source) current characteristics.

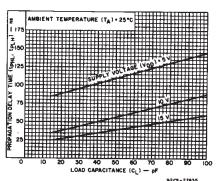


Fig. 6 – Typical propagation delay time vs. load capacitance—data to Q.

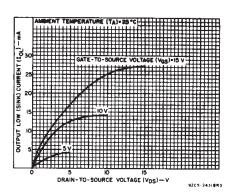


Fig. 2 – Typical output low (sink) current characteristics.

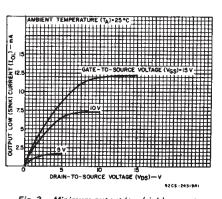


Fig. 3 — Minimum output low (sink) current characteristics,

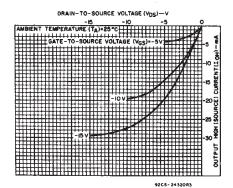


Fig. 4 — Typical output high (source) current characteristics,

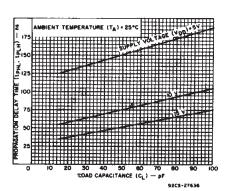


Fig. 7 — Typical propagation delay time vs. load capacitance—data to  $\overline{\Omega}$ .

### CD4042B Types

DYNAMIC ELECTRICAL CHARACTERISTICS at T<sub>A</sub> = 25°C; Input t<sub>r</sub> , t<sub>f</sub> = 20 ns, C<sub>L</sub> = 50 pF, R<sub>L</sub> = 200 K $\Omega$ 

CHARACTERISTIC	V <sub>DD</sub>	LIM	UNITS	
	(4)	Тур.	Max.	1
Propagation Delay Time: tpHL , tpLH Data In to Q	5 10 15	110 55 40	220 110 80	ns
Data In to Q	5 10 15	150 75 50	300 150 100	ns
Clock to Q	5 10 15	225 100 80	450 200 160	ns
Clock to Q	5 10 15	250 115 90	500 230 180	ns
Transition Time: tTHL, tTLH	5 10 15	100 50 40	200 100 80	ns
Minimum Clock Pulse Width, t <sub>W</sub>	5 10 15	100 50 30	200 100 60	ns
Minimum Hold Time, t <sub>H</sub>	5 10 15	60 30 25	120 60 50	ns
Minimum Setup Time, t <sub>S</sub>	5 10 15	0 0 0	50 30 25	ns
Clock Input Rise or Fall Time: t <sub>r</sub> , t <sub>f</sub>	5,10 15	Not rise or fall time sensitive.		μS
Input Capacitance, C <sub>IN</sub> Polarity Input	_	5	7.5	ρF
All Other Inputs		7.5	15	pF

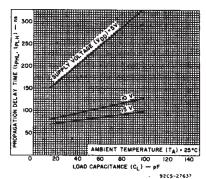


Fig. 8 — Typical propagation delay time vs. load capacitance—clock to Q

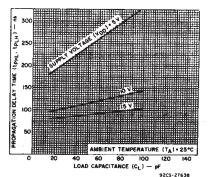
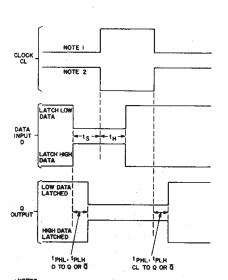


Fig. 9 — Typical propagation delay time vs. load capacitance—clock to  $\overline{\mathbf{Q}}$ .



NOTES:

1. FOR POSITIVE CLOCK EDGE, INPUT DATA IS LATCHED WHEN POLARITY IS LOW.

2. FOR NEGATIVE CLOCK EDGE, INPUT DATA IS LATCHED WHEN POLARITY IS NIGH.

92CS-27630 Fig. 12 – Dynamic test parameters.

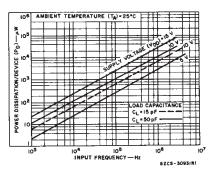


Fig. 10 — Typical power dissipation vs. frequency.

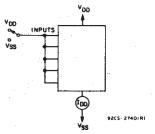


Fig. 13 - Quiescent device current test circuit,

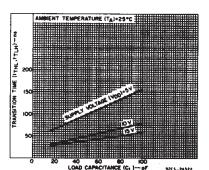


Fig. 11 — Typical transition time vs. load capacitance.

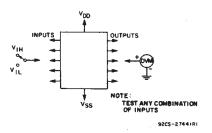


Fig. 14 - Input voltage test circuit.

# CD4042B Types

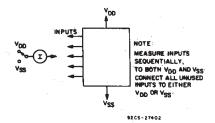
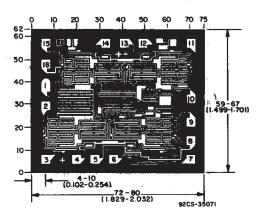


Fig. 15  $\pm$  Input current test circuit.

#### Chip Dimensions and Pad Layout



Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10<sup>-3</sup> inch).



#### PACKAGE OPTION ADDENDUM

28-Feb-2005

#### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
CD4042BD	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4042BDR	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4042BDT	ACTIVE	SOIC	D	16	250	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4042BDW	ACTIVE	SOIC	DW	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
CD4042BDWR	ACTIVE	SOIC	DW	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
CD4042BE	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
CD4042BF	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
CD4042BF3A	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
CD4042BM	OBSOLETE	SOIC	D	16		None	Call TI	Call TI
CD4042BNSR	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4042BPW	ACTIVE	TSSOP	PW	16	90	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
CD4042BPWR	ACTIVE	TSSOP	PW	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM

 $<sup>^{(1)}</sup>$  The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

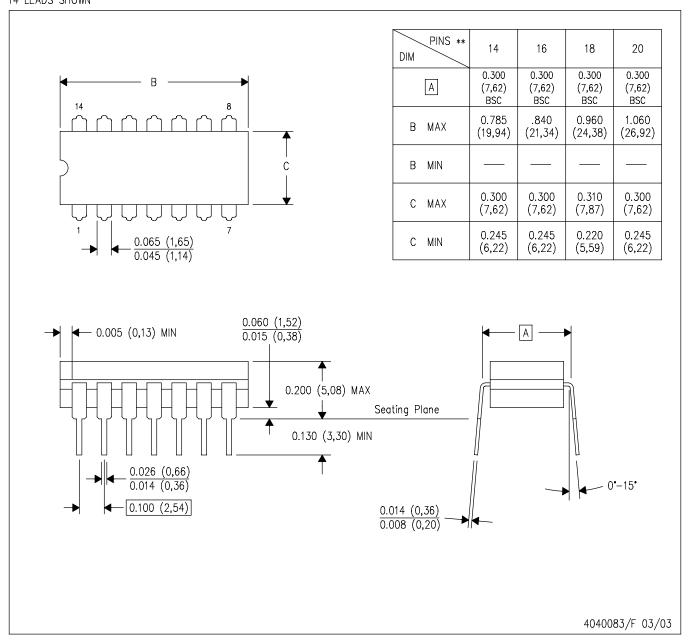
Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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### 14 LEADS SHOWN

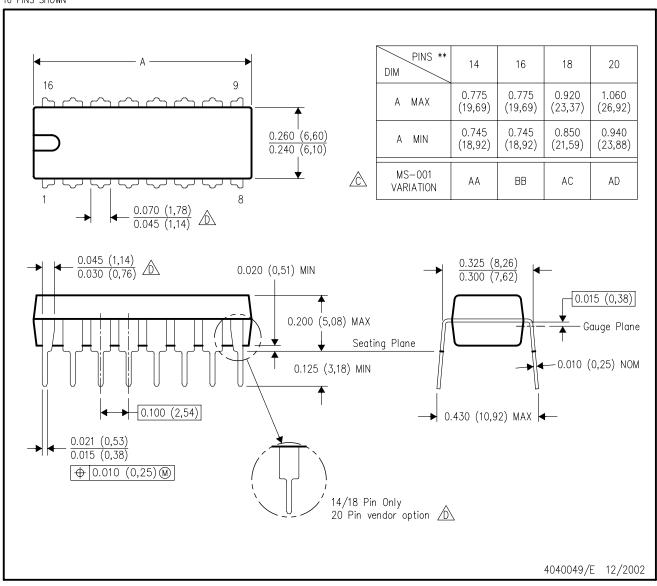


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

### N (R-PDIP-T\*\*)

### PLASTIC DUAL-IN-LINE PACKAGE

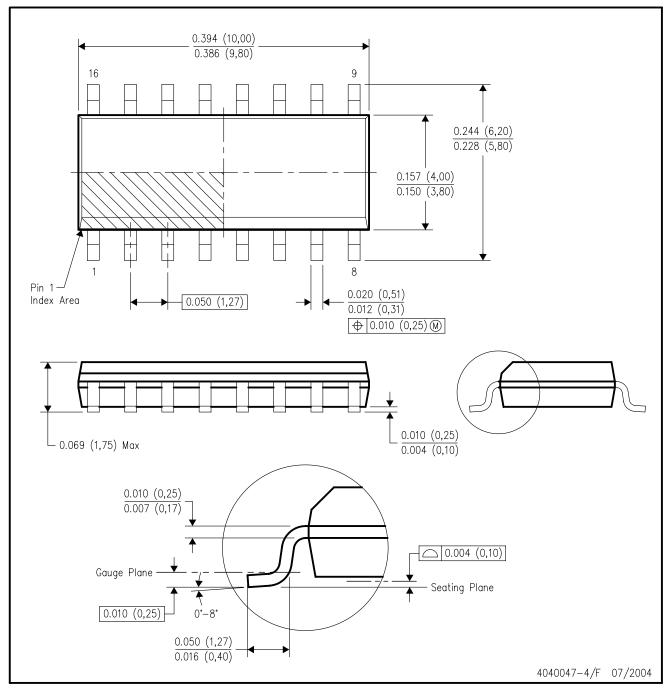
16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.

# D (R-PDSO-G16)

### PLASTIC SMALL-OUTLINE PACKAGE

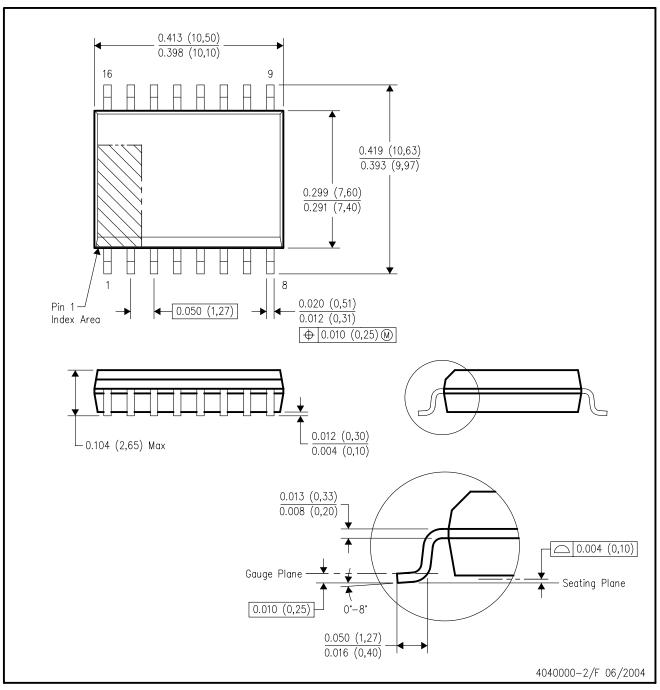


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AC.



# DW (R-PDSO-G16)

### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AA.

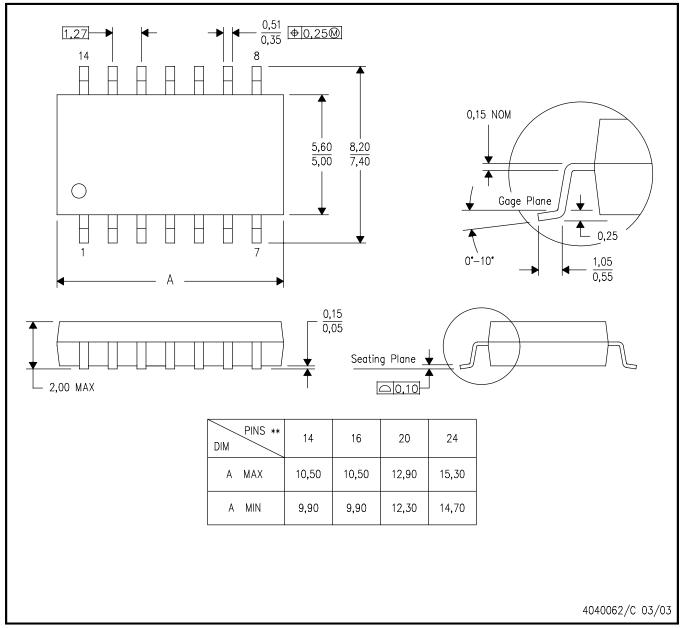


### **MECHANICAL DATA**

### NS (R-PDSO-G\*\*)

#### 14-PINS SHOWN

### PLASTIC SMALL-OUTLINE PACKAGE



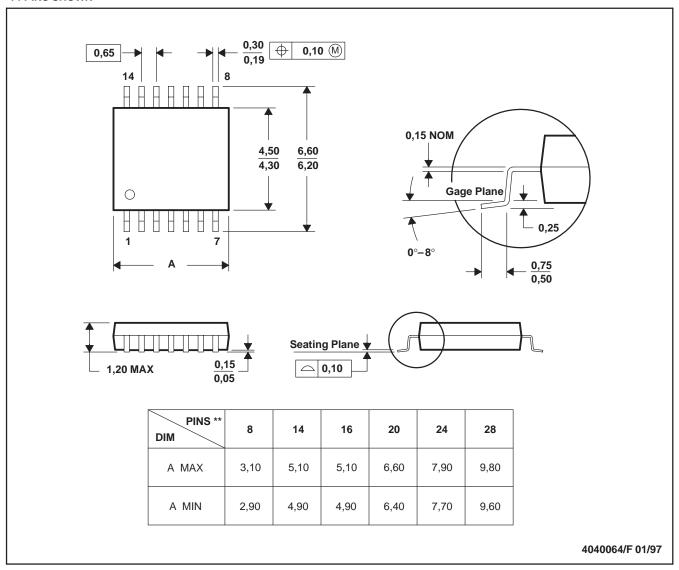
- . All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



### PW (R-PDSO-G\*\*)

#### 14 PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153

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